MULTI-LINE LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The SMP6LLCxx-2P Series are high powered multi-line low capacitance transient voltage suppressor arrays that provides board level protection for standard TTL and MOS bus line applications against the damaging effects of ESD, tertiary lightning and switching transients.

The series has a peak pulse power rating of 400 Watts for an $10/1000\mu s$ waveshape and meets the IEC 61000-4-2, IEC 61000-4-4 and IEC 61000-4-5 requirements.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 100A
- 100A (2/10µs) per Bellcore GR-1089 (Intra Building)
- 400 Watts Peak Pulse Power per Line (tp = 10/1000µs)
- 3,900 Watts Peak Pulse Power per Line (tp = 8/20μs)
- ITKU.20 I_{DD} @ 40A (5/310μs)
- Bidirectional Configuration
- · High Surge Capabilities
- Protects 2 Bidirectional Lines
- Low Capacitance: 5pF
- RoHS Compliant
- REACH Compliant

MECHANICAL CHARACTERISTICS

- Molded JEDEC SO-16 Package
- Approximate Weight: 0.15 grams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:

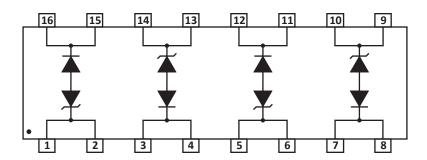
Pure-Tin - Sn, 100: 260-270°C

- 16mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

APPLICATIONS

- T1/E1
- Customer Premise Equipment (CPE)
- Telecommunication Equipment
- Wireless Communication Equipment

PIN CONFIGURATION

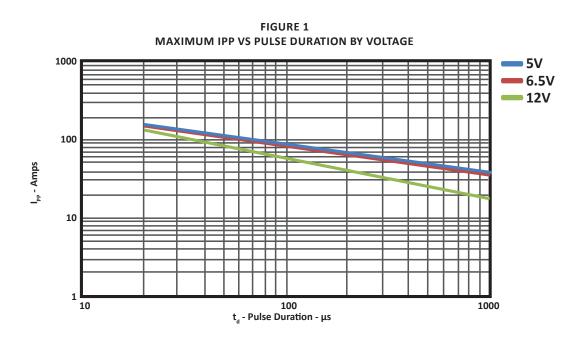


TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified									
PARAMETER SYMBOL VALUE UNITS									
Operating Temperature	T _L	-55 to 150	°C						
Storage Temperature	T _{stg}	-55 to 150	°C						
Peak Pulse Power (tp = 8/20μs) - See Figure 2	P _{PP}	3,900	Watts						
Peak Pulse Power (tp = 10/1000μs) - See Figure 2	P _{PP}	400	Watts						

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER (Note 1)	RATED STAND-OFF VOLTAGE	MINIMUM BRE AKDO WN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (Fig. 3)	MAXIMUM LEAKA GE CURRENT	TYPICAL CAPACITANCE				
	V _{wm} VOLTS	@1mA V _(BR) VOLTS	@ 8/20μS V _c @ Ι _{թթ}	@V _{wм} Ι _D μΑ	@0V, 1MHz C pF				
SMP6LLC05-2P	5.0	6.0	26.0V @ 150.0A	300	5				
SMP6LLC6.5-2P	6.5	7.2	28.0V @ 150.0A	300	5				
SMP6LLC12-2P	12.0	13.3	35.0V @ 140.0A	2	5				

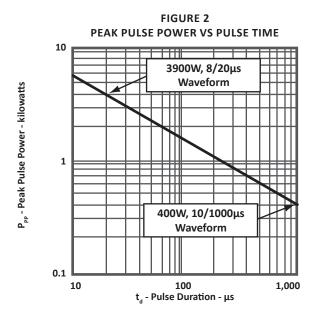
NOTES

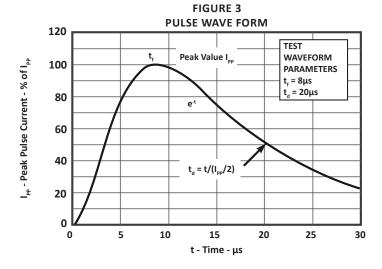


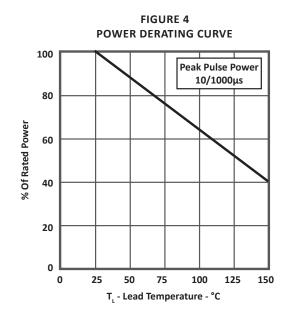
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 $^{1. \ \ \, \}text{Do not surge from pins } 15/16 \ \text{to } 1/2, \ 3/4 \ \text{to } 13/14, \ 11/12 \ \text{to } 5/6 \ \text{and } 7/8 \ \text{to } 9/10. \ PIV \ \text{typically greater than } 100 \ \text{Volts for each rectifier diode.}$

TYPICAL DEVICE CHARACTERISTICS

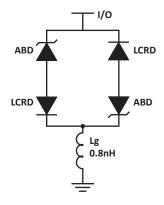






SPICE MODEL

FIGURE 1 SPICE MODEL



ABD - Avalanche Breakdown Diode (TVS) LCRD: Low Capacitance Rectifier Diode Lg - Lead Inductance

TABLE 1 - SPICE PARAMETERS								
PARAMETER	UNIT	ABD(TVS)	LCRD					
BV	V	See Table 2	200					
IBV	μΑ	1	0.01					
C _{jo}	pF	See Table 2	5					
I _s	А	See Table 2	1E-13					
Vj	V	0.6	0.6					
М	-	0.33	0.33					
N	-	1	1					
R_s	Ohms	See Table 2	0.31					
TT	S	1E-8	1E-9					
EG	eV	1.11	1.11					

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS								
PART NUMBER B _v (VOLTS) C _{io} (pF) I _s (AMPS) Rs(OHM								
SMP6LLC05-2P	6.0	3000	1E-11	0.075				
SMP6LLC6.5-2P	7.2	2600	1E-11	0.075				
SMP6LLC12-2P	13.3	1150	1E-13	0.080				

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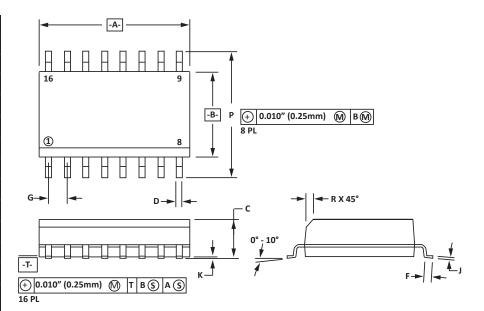


SO-16 PACKAGE INFORMATION

OUTLINE DIMENSIONS								
DIM	MILLIM	IETER S	INCHE S					
ווועו	MIN	MAX	MIN	MAX				
А	9.80	10.00	0.386	0.393				
В	3.80	4.00	0.150	0.157				
С	1.35	1.75	0.054	0.068				
D	0.35	0.49	0.014	0.019				
F	0.40	1.25	0.016	0.049				
G	1.27	BSC	0.05	BSC				
J	0.18	0.25	0.007	0.009				
К	0.10	0.25	0.004	0.008				
Р	5.80	6.20	0.229	0.244				
R	0.25	0.50	0.010	0.019				

NOTES

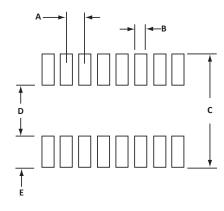
- 1. -T- = Seating plane and datum surface.
- 2. Dimensions "A" and "B" are datum.
- 3. Dimensions "A" and "B" do not include mold protrusion.
- 4. Maximum mold protrusion is 0.015" (0.380mm) per side.
- 5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
- 6. Dimensions are exclusive of mold flash and metal burrs.



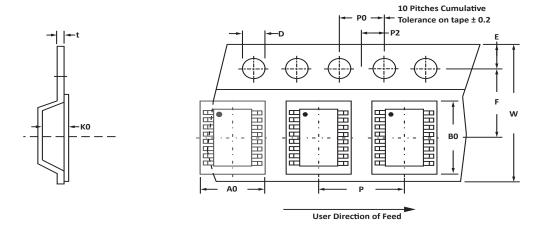
PAD LAYOUT DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
	MIN	MAX	MIN	MAX				
Α	1.14	1.40	0.045	0.055				
В	0.64	0.89	0.025	0.035				
С	6.22	6.22 -		-				
D	3.94	4.17	0.155	0.165				
Е	1.02	1.27	0.040	0.050				

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	P0	P2	Р	tmax
178mm (7")	16mm	6.50 ± 0.10	10.30 ± 0.10	2.10 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	16.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	4.00 ± 0.10	0.25

NOTES

- 1. Dimensions are in millimeters.
- 2. Surface mount product is taped and reeled in accordance with EIA-481.
- 3. Suffix T7 = 7" Reel 1,000 pieces per 16mm tape.
- 4. Suffix T13 = 13" Reel 2,500 pieces per 16mm tape.
- 5. Bulk product shipped in tubes of 48 pieces per tube.
- 6. Marking on Part part number, date code, logo and pin one defined by dot on top of package.

BASE PART NUMBER	E PART NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE						
SMP6LLCxx-2P	N/A	-T7	1,000	7"	48		
SMP6LLCxx-2P	SMP6LLCxx-2P N/A -T13 2,500 13"						
This device is only available in a Lead-Free configuration.							

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COMPANY INFORMATION

COMPANY PROFILE

In business more than 20 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers high performance interface and linear products. They include analog switches; multiplexers; LED drivers; LED wafer die for ESD protection; audio control ICs; RF and related high frequency products.

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